TinyLogic UHS 2-Input Non-Inverting Multiplexer

Description

The NC7SZ157 is a single, high performance, 2–to–1 CMOS non–inverting multiplexer from ON Semiconductor's Ultra–High Speed series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a broad $V_{\rm CC}$ operating range. The device is specified to operate over the 1.65 V to 5.5 V $V_{\rm CC}$ operating range. The inputs and outputs are high impedance when $V_{\rm CC}$ is 0 V. Inputs tolerate voltages up to 5.5 V independent of $V_{\rm CC}$ operating range.

Features

- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- Ultra High-Speed
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPakTM Packages
- Space-Saving SC70 Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

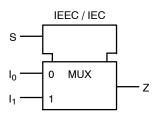


Figure 1. Logic Symbol



ON Semiconductor®

www.onsemi.com

MARKING DIAGRAMS



SIP6 1.45x1.0 CASE 127EB





UDFN6 1.0X1.0, 0.35P CASE 517DP





SC-88 (SC-70 6 Lead) 1.25x2 CASE 419AD-01



B9, ZF7

= Specific Device Code

KK XY Z

= 2-Digit Date Code Format = Assembly Plant Code

= 2-Digit Lot Run Traceability Code

|----| |--

Year Coding SchemePlant Code Identifier

= Die Run Code

= Eight-Week Datacoding Scheme

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

Pin Configurations

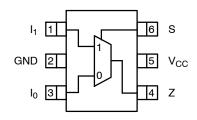


Figure 2. SC70 (Top View)

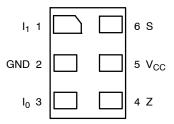
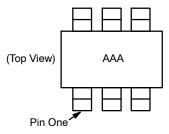


Figure 3. MicroPak (Top Through View)



NOTES:

- AAA represents product code top mark (see Ordering Information).
 Orientation of top mark determines pin one location.
 Reading the top mark left to right, pin one is the lower left pin.

Figure 4. Pin 1 Orientation

PIN DEFINITIONS

| Pin # SC70 | Pin # MicroPak | Name | Description |
|------------|----------------|-----------------|----------------|
| 1 | 1 | I ₁ | Data Input |
| 2 | 2 | GND | Ground |
| 3 | 3 | I ₀ | Data Input |
| 4 | 4 | Z | Output |
| 5 | 5 | V _{CC} | Supply Voltage |
| 6 | 6 | S | Control Input |

FUNCTION TABLE

| Inputs | | | Output |
|--------|----------------|----------------|---|
| S | I ₁ | l _o | $Z = (I_0) \cdot (S) + (I_1) \cdot (S)$ |
| L | Х | L | L |
| L | Х | Н | Н |
| Н | L | Х | L |
| Н | Н | Х | Н |

H = HIGH Logic Level L = LOW Logic Level X = Don't Care

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | | Min | Max | Unit |
|-------------------------------------|--------------------------------------|------------------------------|------|------|------|
| V _{CC} | Supply Voltage | Supply Voltage | | 6.5 | V |
| V _{IN} | DC Input Voltage | | -0.5 | 6.5 | V |
| V _{OUT} | DC Output Voltage | | -0.5 | 6.5 | V |
| I _{IK} | DC Input Diode Current | V _{IN} ≤ 0.5 V | - | -50 | mA |
| I _{OK} | DC Output Diode Current | $V_{OUT} \le -0.5 \text{ V}$ | - | -50 | mA |
| I _{OUT} | DC Output Current | | - | ±50 | mA |
| I _{CC} or I _{GND} | DC V _{CC} or Ground Current | | - | ±50 | mA |
| T _{STG} | Storage Temperature Range | | -65 | +150 | °C |
| TJ | Junction Temperature Under Bias | | - | +150 | °C |
| T _L | Junction Lead Temperature (Soldering | g, 10 Seconds) | - | +260 | °C |
| P_{D} | Power Dissipation at +85°C | SC70-6 | - | 190 | mW |
| | | MicroPak-6 | - | 327 | |
| | | MicroPak2™-6 | - | 327 | |
| ESD | Human Body Model, JEDEC: JESD22–A114 | | - | 4000 | V |
| | Charge Device Model, JEDEC: JESD | 22-C101 | - | 2000 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------------------|-------------------------------|---|------|-----------------|------|
| V _{CC} | Supply Voltage Operating | | 1.65 | 5.50 | V |
| | Supply Voltage Data Retention | | 1.50 | 5.50 | |
| V _{IN} | Input Voltage | | 0 | 5.5 | V |
| V _{OUT} | Output Voltage | | 0 | V _{CC} | V |
| T _A | Operating Temperature | | -40 | +85 | °C |
| t _r , t _f | Input Rise and Fall Times | V_{CC} at 1.8 V \pm 0.15 V, 2.5 V \pm 0.2 V | 0 | 20 | ns/V |
| | | V _{CC} at 3.3 V ±0.3 V | 0 | 10 | 1 |
| | | V _{CC} at 5.0 V ±0.5 V | 0 | 5 | 1 |
| $\theta_{\sf JA}$ | Thermal Resistance | SC70-6 | - | 659 | °C/W |
| | | MicroPak | - | 382 | |
| | | MicroPak2 | - | 382 | °C/W |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

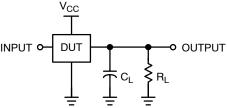
DC ELECTICAL CHARACTERISTICS

| | | | | | T, | ₄ = +25 | °C | T _A = -40 | to +85°C | |
|------------------|------------------------------|---------------------|--------------------|--|----------------------|--------------------|----------------------|----------------------|----------------------|------|
| Symbol | Parameter | V _{CC} (V) | C | Conditions | Min | Тур | Max | Min | Max | Unit |
| V _{IH} | HIGH Level | 1.65 to 1.95 | | | 0.65 V _{CC} | _ | - | 0.65 V _{CC} | - | V |
| | Input Voltage | 2.30 to 5.50 | | | 0.70 V _{CC} | - | - | 0.70 V _{CC} | - | |
| V _{IL} | LOW Level | 1.65 to 1.95 | | | - | _ | 0.35 V _{CC} | - | 0.35 V _{CC} | V |
| | Input Voltage | 2.30 to 5.50 | | | - | _ | 0.30 V _{CC} | - | 0.30 V _{CC} | |
| V _{OH} | HIGH Level | 1.65 | $V_{IN} = V_{IL}$ | I _{OH} = -100 μA | 1.55 | 1.65 | - | 1.55 | - | V |
| | Output Voltage | 2.30 | or V _{IH} | | 2.20 | 2.30 | - | 2.20 | - | |
| | | 3.00 | | | 2.90 | 3.00 | - | 2.90 | - | |
| | | 4.50 | | | 4.40 | 4.50 | - | 4.40 | - | |
| | | 1.65 | | I _{OH} = -4 mA | 1.29 | 1.52 | - | 1.29 | - | |
| | | 2.30 | | I _{OH} = -8 mA | 1.90 | 2.15 | - | 1.90 | - | |
| | | 3.00 | | I _{OH} = -16 mA | 2.40 | 2.80 | - | 2.40 | - | |
| | | 3.00 | | I _{OH} = -24 mA | 2.30 | 3.68 | - | 2.30 | - | |
| | | 4.50 | | I _{OH} = -32 mA | 3.90 | 4.20 | - | 3.80 | - | |
| V _{OL} | LOW Level | 1.65 | $V_{IN} = V_{IL}$ | I _{OL} = 100 μA | - | 0 | 0.10 | - | 0.10 | V |
| | Output Voltage | 2.30 | or V _{IH} | | - | 0 | 0.10 | - | 0.10 | |
| | | 3.00 | | | - | 0 | 0.10 | - | 0.10 | |
| | | 4.50 | | | - | 0 | 0.10 | - | 0.10 | |
| | | 1.65 | | I _{OL} = 4 mA | - | 0.08 | 0.24 | - | 0.24 | |
| | | 2.30 | | I _{OL} = 8 mA | - | 0.10 | 0.30 | - | 0.30 | |
| | | 3.00 | | I _{OL} = 16 mA | - | 0.15 | 0.40 | - | 0.40 | |
| | | 3.00 | | I _{OL} = 24 mA | - | 0.22 | 0.55 | - | 0.55 | |
| | | 4.50 | | I _{OL} = 32 mA | - | 0.22 | 0.55 | - | 0.55 | |
| I _{IN} | Input Leakage Current | 1.65 to 5.5 | | V _{IN} = 5.5 V, GND | - | _ | ±0.1 | - | ±1 | μΑ |
| I _{OFF} | Power Off Leakage Current | 0 | | V _{IN} or V _{OUT} = 5.5 V | - | _ | 1.0 | - | 10 | μΑ |
| I _{CC} | Quiescent Supply Current | 1.65 to 5.50 | | V _{IN} = 5.5 V, GND | - | _ | - | - | 10 | μΑ |

AC ELECTRICAL CHARACTERISTICS

| | | | | - | T _A = +25°C | ; | T _A = -40 | to +85°C | |
|-------------------------------------|---------------------------------------|---------------------|-------------------------|-----|------------------------|------|----------------------|----------|------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min | Тур | Max | Min | Max | Unit |
| t _{PLH} , t _{PHL} | Propagation Delay S to Z | 1.80 ±0.15 | C _L = 15 pF, | - | 6.0 | 11.5 | - | 12.0 | ns |
| | (Figure 5, 6) | 2.50 ±0.20 | $R_L = 1 M\Omega$, | - | 3.5 | 6.1 | _ | 6.5 | |
| | | 3.30 ±0.30 | | - | 2.6 | 4.1 | - | 4.5 | |
| | | 5.00 ±0.50 | | - | 1.9 | 3.2 | _ | 3.5 | |
| | Propagation Delay I _n to Z | 1.80 ±0.15 | C _L = 15 pF, | - | 5.9 | 10.0 | - | 10.5 | |
| | (Figure 5, 6) | 5.00 ±0.50 | $R_L = 1M\Omega$, | - | 3.5 | 5.8 | - | 6.1 | |
| | | 3.30 ±0.30 | | - | 2.6 | 3.9 | _ | 4.2 | |
| | | 5.00 ±0.50 | | - | 1.9 | 3.1 | _ | 3.3 | |
| | Propagation Delay S to Z | 3.30 ±0.30 | C _L = 50 pF, | - | 3.2 | 4.8 | _ | 5.2 | |
| | (Figure 5, 6) | 5.00 ±0.50 | $R_L = 500 \Omega$, | - | 2.4 | 3.8 | _ | 4.1 | |
| | Propagation Delay I _n to Z | 3.30 ±0.30 | C _L = 50 pF, | - | 3.2 | 4.6 | <u> </u> | 5.0 | |
| | (Figure 5, 6) | 5.00 ±0.50 | $R_L = 500 \Omega$, | - | 2.4 | 3.7 | <u> </u> | 4.0 | |
| C _{IN} | Input Capacitance | 0.00 | | - | 2 | - | _ | _ | pF |
| C _{PD} | Power Dissipation Capacitance | 3.30 | | - | 14 | - | <u> </u> | _ | pF |
| | (Note 4) (Figure 7) | 5.00 | | - | 17 | - | _ | - | |

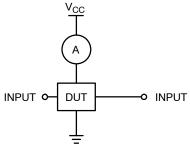
^{4.} CPD is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. CPD is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).$



NOTE:

5. C_L includes load and stray capacitance; inputs PRR = 1.0 MHz, t_W = 500 ns.

Figure 5. AC Test Circuit



 t_{PLH} Out of Phase 50% OUTPUT t_{PLH} t_{PHL} In Phase 50% **OUTPUT** Figure 6. AC Waveforms

 $t_r = 3 \text{ ns} -$

INPUT

90%

t_W

50%

10%

50%

GND

 V_{OL}

 V_{OH}

 V_{OL}

NOTE:

6. Input = AC Waveform; PRR = Variable; Duty Cycle = 50%.

Figure 7. I_{CCD} Test Circuit

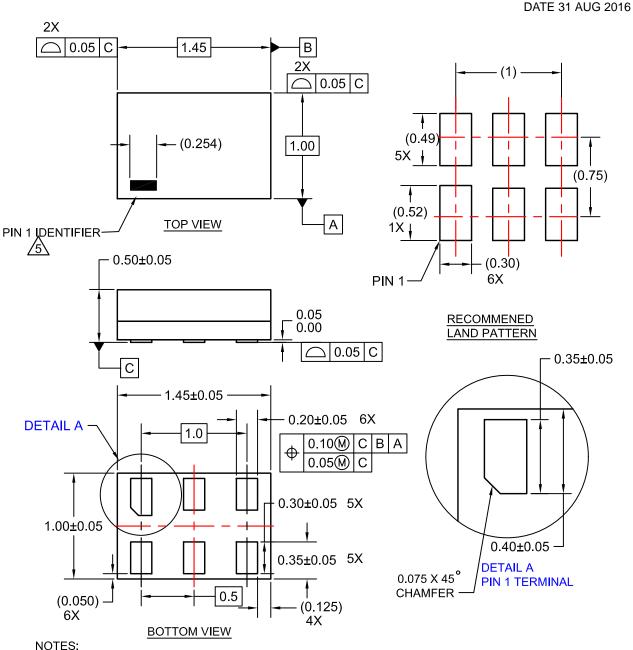
DEVICE ORDERING INFORMATION

| Device | Top Mark | Packages | Shipping [†] |
|-------------|----------|--|-----------------------|
| NC7SZ157P6X | ZF7 | 6-Lead SC70, EIAJ SC-88, 1.25 mm Wide | 3000 / Tape & Reel |
| NC7SZ157L6X | B9 | 6-Lead MicroPak, 1.00 mm Wide | 5000 / Tape & Reel |
| NC7SZ157FHX | B9 | 6-Lead, MicroPak2, 1x1 mm Body, .35 mm Pitch | 5000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MicroPak and MicroPak2 are trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.





- 1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009
- /4\PIN ONE IDENTIFIER IS 2X LENGTH OF ANY
 - OTHER LINE IN THE MARK CODE LAYOUT.

| DOCUMENT NUMBER: | 98AON13590G | Electronic versions are uncontrolled except when | | |
|------------------|---------------------------|--|----|--|
| STATUS: | ON SEMICONDUCTOR STANDARD | accessed directly from the Document Repository. Printe versions are uncontrolled except when stamped | ed | |
| NEW STANDARD: | | "CONTROLLED COPY" in red. | | |
| DESCRIPTION: | SIP6 1.45X1.0 | PAGE 1 OF | 2 | |

| ON Semiconductor® | ON |
|-------------------|----|
|-------------------|----|

DOCUMENT NUMBER: 98AON13590G

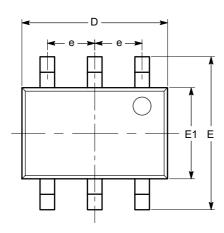
PAGE 2 OF 2

| ISSUE | REVISION | DATE |
|-------|--|-------------|
| 0 | RELEASED FOR PRODUCTION FROM FAIRCHILD MAC06A TO ON SEMICONDUCTOR. REQ. BY B. MARQUIS. | 31 AUG 2016 |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |

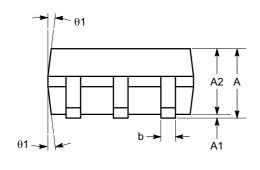
ON Semiconductor and una are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD-01 ISSUE A

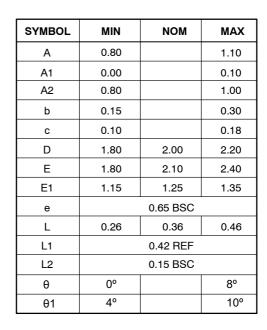
DATE 07 JUL 2010

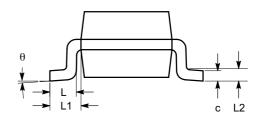


TOP VIEW



SIDE VIEW





END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

| DOCUMENT NUMBER: | 98AON34266E | Electronic versions are uncontrolle accessed directly from the Document versions are uncontrolled except "CONTROLLED COPY" in red. | Repository. Printed | |
|------------------|------------------------------|--|---------------------|--|
| STATUS: | ON SEMICONDUCTOR STANDARD | | | |
| REFERENCE: | | | | |
| DESCRIPTION: | SC-88 (SC-70 6 LEAD), 1.25X2 | | PAGE 1 OF 2 | |



DOCUMENT NUMBER: 98AON34266E

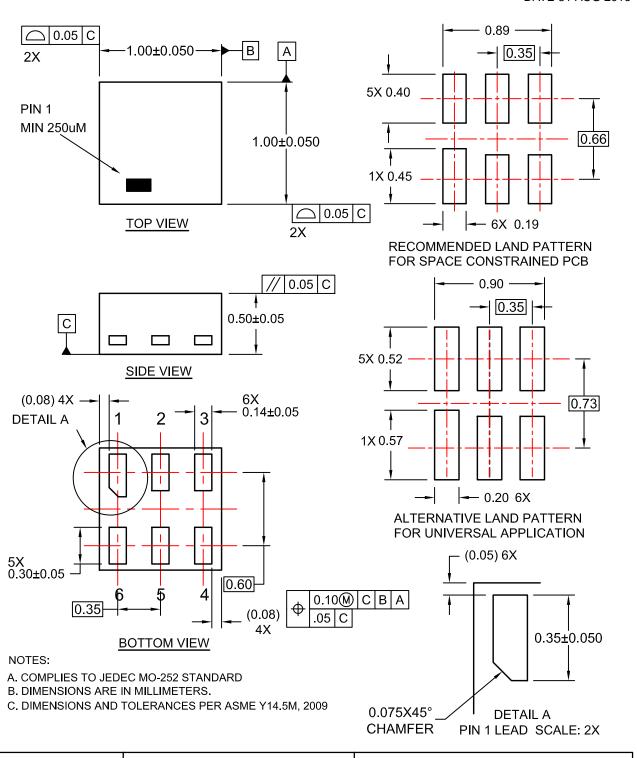
PAGE 2 OF 2

| ISSUE | REVISION | DATE |
|-------|---|-------------|
| 0 | RELEASED FOR PRODUCTION FROM POD #SC706-023-02 TO ON SEMICONDUCTOR. REQ. BY B. BERGMAN. | 19 DEC 2008 |
| Α | ADDED SC-88 TO DESCRIPTION AND TITLE. REQ. BY D. TRUHITTE. | 07 JUL 2010 |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights or the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

UDFN6 1.0X1.0, 0.35P CASE 517DP ISSUE O

DATE 31 AUG 2016



| DOCUMENT NUMBER: | 98AON13593G | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printe versions are uncontrolled except when stamped | ' ' |
|------------------|---------------------------|---|-------------|
| STATUS: | ON SEMICONDUCTOR STANDARD | | ' ' |
| NEW STANDARD: | | "CONTROLLED COPY" in red. | |
| DESCRIPTION: | UDFN6 1.0X1.0, 0.35P | | PAGE 1 OF 2 |



DOCUMENT NUMBER: 98AON13593G

PAGE 2 OF 2

| ISSUE | REVISION | DATE |
|-------|--|-------------|
| 0 | RELEASED FOR PRODUCTION FROM FAIRCHILD MGF06A TO ON SEMICONDUCTOR. REQ. BY B. MARQUIS. | 31 AUG 2016 |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |

ON Semiconductor and una are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. anising out of the application of use of any product of circuit, and specifically disclaims any and an inability, including without infiniation special, consequential of inclental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates. and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative